



(3.81 mm) .150" **UPT SERIES**

BLADE 20 A POWER HEADER

20.1 A

16.9 A

15.5 A

SPECIFICATIONS

For complete specifications see www.samtec.com?UPT

Insulator Material: Black LCF

Terminal Material: BeCu

Plating: Sn or Au over 50 μ"

(1.27 μm) Ni

Operating Temp Range:
-55 °C to +105 °C with Tin;
-55 °C to +125 °C with Gold

-55 °C to +125 °C With Gold Voltage Rating: 438 VAC/620 VDC Standard Creepage: (5.5 mm) .217" (with -V) (2.97 mm) .117" (with -RA) Standard Clearance: (1.51 mm) .059") **RoHS Compliant:**

Lead-Free Solderable:

Mates with:

2

3

4

8

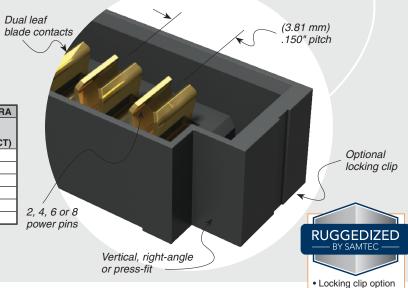
UPT-V/UPS-V UPT-RA/UPS-RA CURRENT CURRENT PINS RATING RATING PER CONTACT) (PER CONTACT) 23 A 23.5 A

18.6 A

17.5 A

16.7 A

13.3 A -L PLATING



RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



CREEPAGE **CLEARANCE**



Selectively loading contacts achieves customer specific creepage and clearance requirements. Contact asp@samtec.com

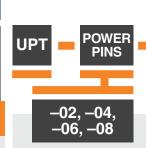
ALSO AVAILABLE (MOQ Required)

· Solder leads for (2.36 mm) .093" thick board

TOOLING

Press-fit tooling available.

Some sizes, styles and options are non-standard, non-returnable.



STYLE

LEAD

-01= RA only -03.0 = (03.0 mm) `.118" (–V & –PV only)

TAIL LENGTH

-01= Use with (1.60 mm) .062^t Thick PCB (–V & –RA only)

-03= Use with (1.60 mm) .062' Thick PCB (-PV only)

PLATING OPTION

= 10 µ" (0.25 µm) Gold on contact, Matte Tin on tail

= Matte Tin (-RA option only)

-V

= Vertical (Not available with -T plating)

TAIL

–RA = Right-angle -PV = Press-fit.

Vertical

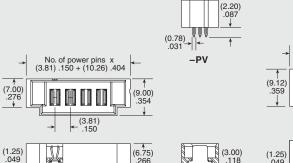
= Locking Clip (Manual placement required) Not available with -PV

option

OTHER

OPTION

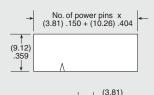
-LC

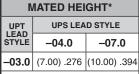


.266

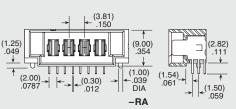
(0.30) (0.12)

(3.00)(1.00)





*Processing conditions will affect mated height.



.118